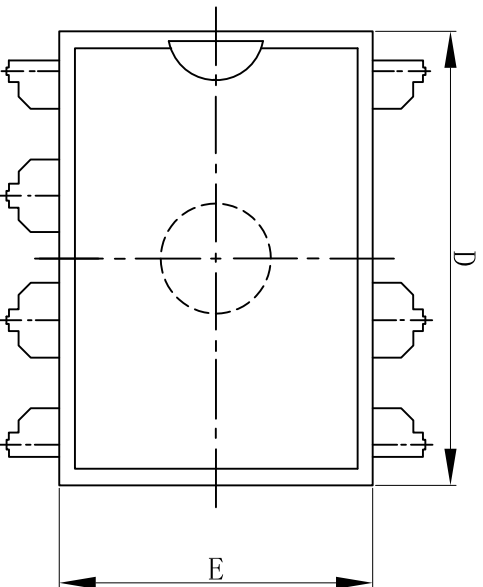
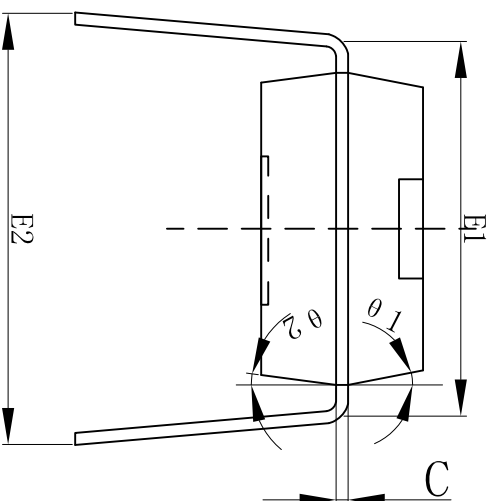
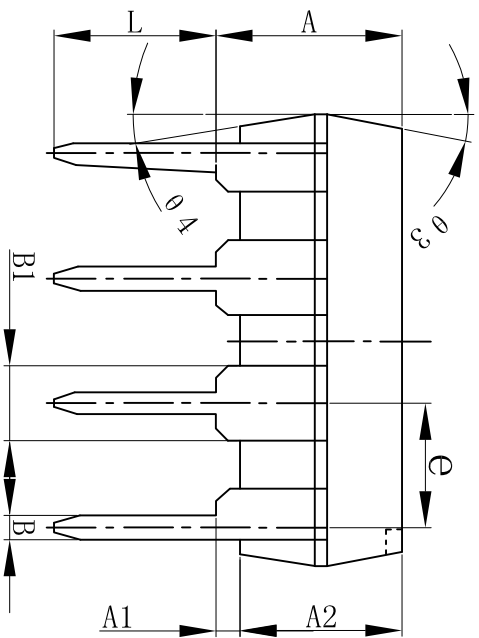




DIP7 PACKAGE OUTLINE DIMENSIONS



| SYMBOL | MILLIMETER | | |
|--------|------------|------|------|
| | MIN | NOM | MAX |
| A | 3.75 | 3.90 | 4.15 |
| A1 | 0.60 | --- | --- |
| A2 | 3.15 | 3.30 | 3.40 |
| B | 0.38 | 0.46 | 0.56 |
| B1 | 1.52 (BSC) | | |
| C | 0.20 | 0.25 | 0.34 |
| D | 9.00 | 9.25 | 9.40 |
| E | 6.20 | 6.35 | 6.50 |
| E1 | 7.35 | 7.62 | 7.85 |
| e | 2.54 (BSC) | | |
| L | 3.00 | 3.30 | 3.60 |
| E2 | 8.00 | 8.40 | 8.80 |
| θ 1 | 8° | ~ | 16° |
| θ 2 | 8° | ~ | 12° |
| θ 3 | 8° | ~ | 14° |
| θ 4 | 6° | ~ | 12° |

技术说明:

- 1) LEADFRAME MATERIAL: COPPER;
引线框架材料: 铜;
- 2) LEADFRAME THICKNESS: 0.254mm;
引线框架厚度: 0.254mm;
- 3) BOTH PACKAGE LENGTH AND WIDTH DO NOT INCLUDE MOLD FLASH;
塑封体长度及宽度尺寸不包括塑封溢胶;
- 4) REFERENCE: JEDEC MS-013, MS-012.
参考标准: JEDEC MS-013, MS-012.